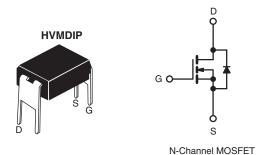


COMPLIANT

### **Power MOSFET**

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	60				
$R_{DS(on)}\left(\Omega\right)$	$V_{GS} = 5.0 \text{ V}$	0.10			
Q <sub>g</sub> (Max.) (nC)	18				
Q <sub>gs</sub> (nC)	4.5				
Q <sub>gd</sub> (nC)	12				
Configuration	Single				



#### **FEATURES**

- Dynamic dV/dt Rating
- · For Automatic Insertion
- End Stackable
- · Logic-Level Gate Drive
- R<sub>DS(on)</sub> Specified at V<sub>GS</sub> = 4 V and 5 V
- 175 °C Operating Temperature
- · Fast Switching
- Compliant to RoHS Directive 2002/95/EC

#### **DESCRIPTION**

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The 4 pin DIP package is a low cost machine-insertiable case style which can be stacked in multiple combinations on standard 0.1" pin centers. The dual drain servers as a thermal link to the mounting surface for power dissipation levels up to 1 W.

ORDERING INFORMATION			
Package	HVMDIP		
Lead (Pb)-free	IRLD024PbF		
	SiHLD024-E3		
SnPb	IRLD024		
	SiHLD024		

<b>ABSOLUTE MAXIMUM RATINGS</b> (T <sub>A</sub> = 25 °C, unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V <sub>DS</sub>	60	V	
Gate-Source Voltage			$V_{GS}$	± 10	V	
Continuous Drain Current	V <sub>GS</sub> at 5.0 V	T <sub>A</sub> = 25 °C		2.5	А	
Continuous Drain Current	VGS at 5.0 V	T <sub>A</sub> = 100 °C	I <sub>D</sub>	1.8		
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	20		
Linear Derating Factor				0.0083	W/°C	
Single Pulse Avalanche Energy <sup>b</sup>			E <sub>AS</sub>	91	mJ	
Maximum Power Dissipation	T <sub>A</sub> = 25 °C		P <sub>D</sub>	1.3	W	
Peak Diode Recovery dV/dt <sup>c</sup>	•		dV/dt	4.5	V/ns	
Operating Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 175		
Soldering Recommendations (Peak Temperature)	for 10 s			300 <sup>d</sup>	- °C	

#### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b.  $V_{DD}$  = 25 V, starting  $T_J$  = 25 °C, L = 16 mH,  $R_g$  = 25  $\Omega$ ,  $I_{AS}$  = 2.5 A (see fig. 12).
- c.  $I_{SD} \leq$  17 A,  $dI/dt \leq$  140 A/ $\mu$ s,  $V_{DD} \leq$   $V_{DS}$ ,  $T_{J} \leq$  175 °C.
- d. 1.6 mm from case.

<sup>\*</sup> Pb containing terminations are not RoHS compliant, exemptions may apply

# IRLD024, SiHLD024

# Vishay Siliconix



THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-	120	°C/W	

SPECIFICATIONS (T <sub>J</sub> = 25 °C, unless otherwise noted)							
PARAMETER	SYMBOL	TES	MIN.	TYP.	MAX.	UNIT	
Static					r		
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> =	= 0 V, I <sub>D</sub> = 250 μA	60	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I <sub>D</sub> = 1 mA	-	0.060	-	V/°C
Gate-Source Threshold Voltage	$V_{GS(th)}$	V <sub>DS</sub> =	$V_{GS}$ , $I_{D} = 250 \mu A$	1.0	-	2.0	V
Gate-Source Leakage	$I_{GSS}$	,	$V_{GS} = \pm 10 \text{ V}$	-	-	± 100	nA
Zero Gate Voltage Drain Current	lann	V <sub>DS</sub> :	$= 60 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	-	25	μΑ
Zero date voltage Drain Guirent	I <sub>DSS</sub>	$V_{DS} = 48 \ V_{s}$	$V_{GS} = 0 \text{ V}, T_J = 150 ^{\circ}\text{C}$	-	-	250	μΛ
Drain-Source On-State Resistance	D	$V_{GS} = 5.0 \text{ V}$	$I_D = 1.5A^b$	-	-	0.10	Ω
Dialii-Source Oil-State Hesistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 4.0 V	$I_D = 1.3 A^b$	-	-	0.14	
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub> =	= 25 V, I <sub>D</sub> = 1.5 A <sup>b</sup>	3.7	-	-	S
Dynamic							
Input Capacitance	C <sub>iss</sub>		V <sub>GS</sub> = 0 V	-	870	-	
Output Capacitance	C <sub>oss</sub>		$V_{DS} = 25 \text{ V}$	-	360	-	pF
Reverse Transfer Capacitance	C <sub>rss</sub>	] f = 1.	0 MHz, see fig. 5	-	53	-	
Total Gate Charge	Qg			-	-	18	nC
Gate-Source Charge	Q <sub>gs</sub>	$V_{GS} = 5.0 \text{ V}$	I <sub>D</sub> = 17 A, V <sub>DS</sub> = 48 V see fig. 6 and 13 <sup>b</sup>	-	-	4.5	
Gate-Drain Charge	$Q_{gd}$		goo ngi o ana 10	-	-	12	
Turn-On Delay Time	t <sub>d(on)</sub>	1		-	11	-	
Rise Time	t <sub>r</sub>	Von	= 30 V, I <sub>D</sub> = 17 A	-	110	-	]
Turn-Off Delay Time	t <sub>d(off)</sub>	$R_g = 9.0 \Omega$ , $R_D = 1.7 \Omega$ , see fig. $10^b$		-	23	-	ns
Fall Time	t <sub>f</sub>			-	41	-	1
Internal Drain Inductance	L <sub>D</sub>	Between lead 6 mm (0.25") i		-	4.0	-	
Internal Source Inductance	L <sub>S</sub>	package and center of die contact		-	6.0	-	nH
Drain-Source Body Diode Characteristic	cs	•			ı	·	
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	2.5	
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>			-	-	20	A
Body Diode Voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C, I <sub>S</sub> = 2.5 A, V <sub>GS</sub> = 0 V <sup>b</sup>		-	-	1.5	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>	T <sub>J</sub> = 25 °C, I <sub>F</sub> = 17 A, dl/dt = 100 A/μs <sup>b</sup>		-	110	260	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			-	0.49	1.5	μC
Forward Turn-On Time	t <sub>on</sub>	Intrinsic turn-on time is negligible (turn-on is dominated by L <sub>S</sub> and L <sub>D</sub> )				_D)	

#### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width  $\leq 300~\mu s;$  duty cycle  $\leq 2~\%.$



### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

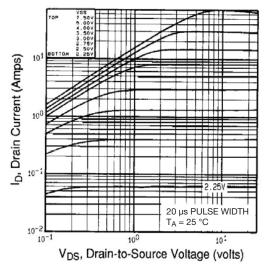


Fig. 1 - Typical Output Characteristics, T<sub>A</sub> = 25 °C

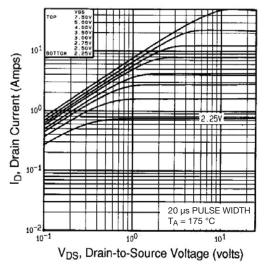


Fig. 2 - Typical Output Characteristics, T<sub>A</sub> = 175 °C

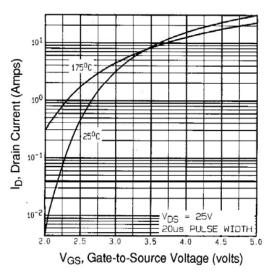


Fig. 3 - Typical Transfer Characteristics

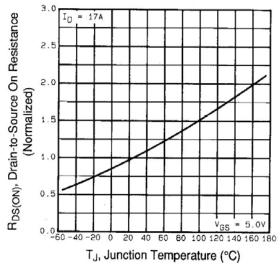


Fig. 4 - Normalized On-Resistance vs. Temperature



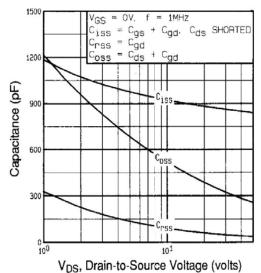


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

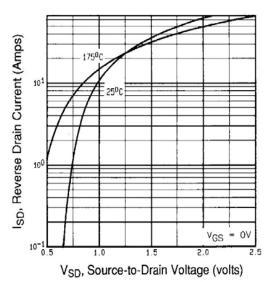


Fig. 7 - Typical Source-Drain Diode Forward Voltage

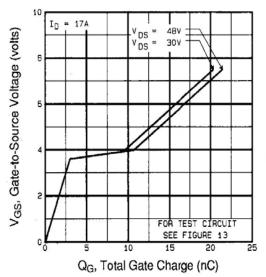


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

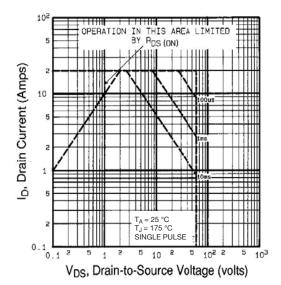


Fig. 8 - Maximum Safe Operating Area



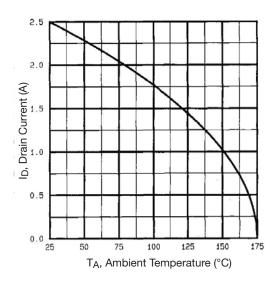


Fig. 9 - Maximum Drain Current vs. Ambient Temperature

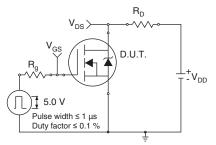


Fig. 10a - Switching Time Test Circuit

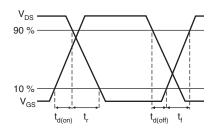


Fig. 10b - Switching Time Waveforms

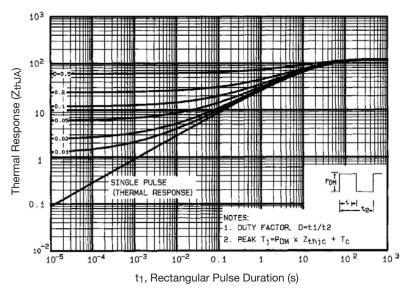


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Ambient



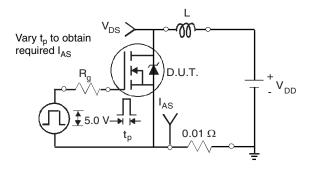


Fig. 12a - Unclamped Inductive Test Circuit

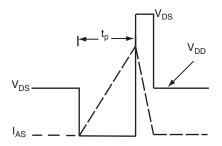


Fig. 12b - Unclamped Inductive Waveforms

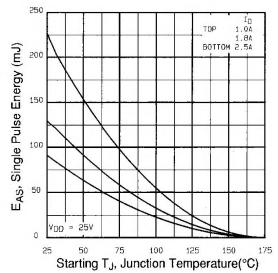


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

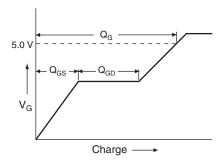


Fig. 13a - Basic Gate Charge Waveform

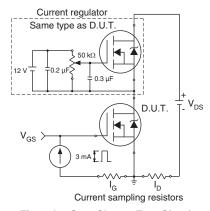
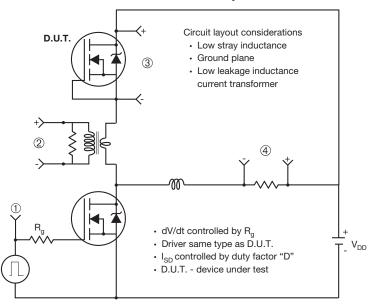


Fig. 13b - Gate Charge Test Circuit





#### Peak Diode Recovery dV/dt Test Circuit



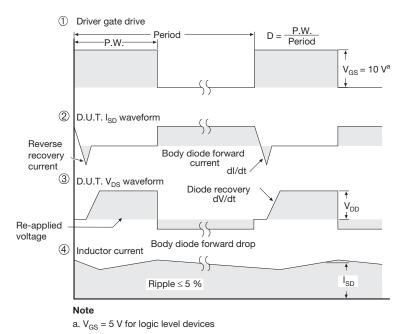
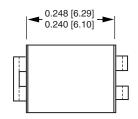
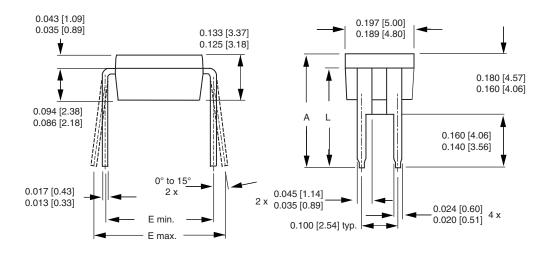


Fig. 14 - For N-Channel

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### **HVM DIP** (High voltage)





	INCHES		MILLIMETERS	
DIM.	MIN.	MAX.	MIN.	MAX.
А	0.310	0.330	7.87	8.38
E	0.300	0.425	7.62	10.79
L	0.270	0.290	6.86	7.36

ECN: X10-0386-Rev. B, 06-Sep-10

DWG: 5974

1. Package length does not include mold flash, protrusions or gate burrs. Package width does not include interlead flash or protrusions.

Document Number: 91361 Revision: 06-Sep-10



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Vishay

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